

## SOT-323 Plastic-Encapsulate MOSFETS

### CJ3139KW P-Channel Power MOSFET

#### GENERAL DESCRIPTION

This Single P-Channel MOSFET has been designed using advanced Power Trench process to optimize the  $R_{DS(ON)}$ .

#### FEATURE

- High-Side Switching
- Low On-Resistance
- Low Threshold
- Fast Switching Speed

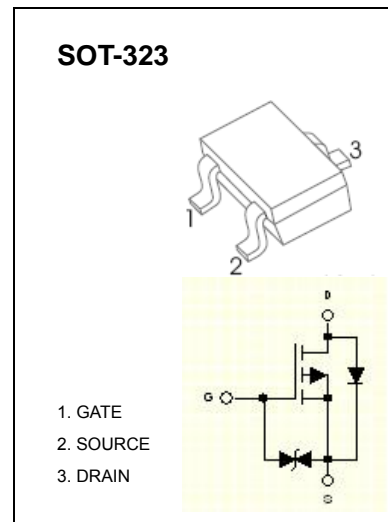
#### APPLICATION

- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories
- Battery Operated Systems
- Power Supply Converter Circuits
- Load/Power Switching Cell Phones, Pagers

#### MARKING: 39K

#### Maximum ratings ( $T_a=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source voltage	$V_{DSS}$	-20	V
Gate-Source Voltage	$V_{GS}$	$\pm 12$	
Drain Current-Continuous	$I_D$	-0.66	A
Drain Current -Pulsed(note1)	$I_{DM}$	-2.64	
Power Dissipation (note 2)	$P_D$	200	mW
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	625	$^{\circ}\text{C}/\text{W}$
Storage Temperature	$T_j$	150	$^{\circ}\text{C}$
Junction Temperature	$T_{stg}$	-55 ~ +150	



**Electrical characteristics (T<sub>a</sub>=25°C unless otherwise noted)**

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>On/Off States</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA	-20			V
Gate-Threshold Voltage(note 3)	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA	-0.35		-1.1	
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±12V			±20	μA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = -20V, V <sub>GS</sub> = 0V			-1	μA
Drain-Source On-State Resistance(note 3)	R <sub>DS(on)</sub>	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -1A			520	mΩ
		V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -800mA			700	
		V <sub>GS</sub> = -1.8V, I <sub>D</sub> = -500mA			950	
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> = -10V, I <sub>D</sub> = -540mA	0.8			S
<b>Dynamic Characteristics(note 4)</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = -16V, V <sub>GS</sub> = 0V, f = 1MHz			170	pF
Output Capacitance	C <sub>oss</sub>				25	
Reverse Transfer Capacitance	C <sub>rss</sub>				15	
<b>Switching Times (note 4)</b>						
Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> = -10V, I <sub>D</sub> = -200mA, V <sub>GS</sub> = -4.5V, R <sub>G</sub> = 10Ω		9		ns
Rise Time	t <sub>r</sub>			5.8		
Turn-Off Delay Time	t <sub>d(off)</sub>			32.7		
Fall Time	t <sub>f</sub>			20.3		
<b>Drain-Source Diode Characteristics</b>						
Drain-Source Diode Forward Voltage (note 3)	V <sub>SD</sub>	I <sub>S</sub> = -0.5A, V <sub>GS</sub> = 0V			-1.2	V

**Notes:**

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. This test is performed with no heat sink at T<sub>a</sub>=25°C.
3. Pulse Test : Pulse Width ≤ 300μs, Duty Cycle ≤ 0.5%.
4. These parameters have no way to verify.